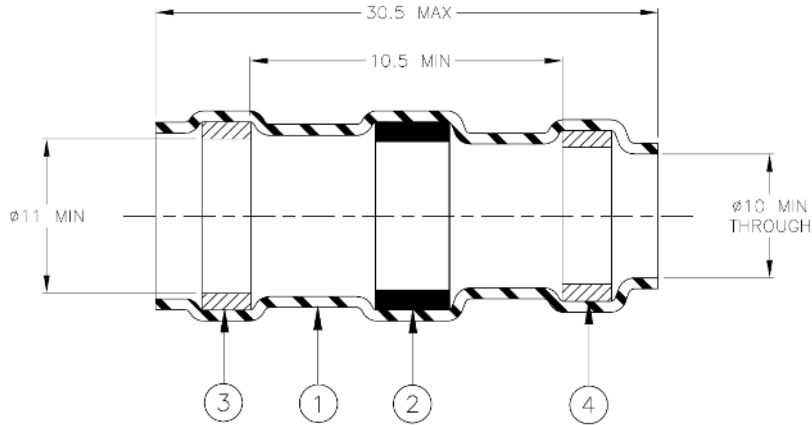


CUSTOMER DRAWING



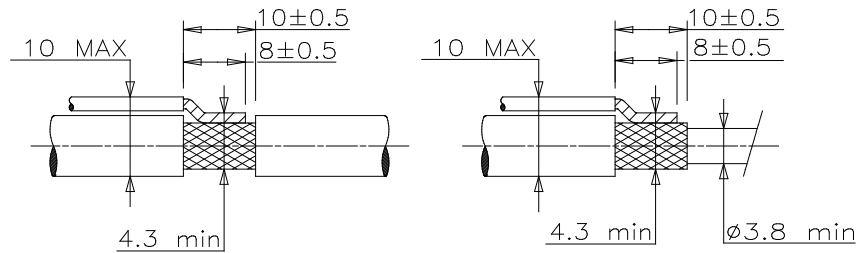
MATERIALS


1. INSULATION SLEEVE: Heat-shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
2. SOLDER PREFORM WITH FLUX:
 SOLDER: TYPE Sn96 per ANSI-J-STD-006.
 FLUX: TYPE ROL1 per ANSI-J-STD-004.
3. MELTABLE SEALING RING: Thermally stabilized thermoplastic. Color: blue.
4. MELTABLE SEALING RING: Thermally stabilized thermoplastic. Color: red.

APPLICATION

1. This controlled soldering device is designed for termination of a nickel plated copper shield on a cable having an insulation rated for at least 150°C.
2. Temperature range: -55°C to +175°C. For application tooling, contact your local TE Connectivity technical service.

For best results, prepare the cable as shown:



		Raychem THERMOFIT DEVICES		TITLE: SOLDERSLEEVE DEVICE SHIELD TERMINATION HIGH TEMPERATURE	
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.				DOCUMENT NO.: B-022-06	
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A		ANGLES: N/A ROUGHNESS IN MICRON		TE Connectivity reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.	
DRAWN BY: M. FORONDA		DATE: 07/10/98		ECO: ECO-20-009432	
		SCALE: None		SIZE: A	
				SHEET: 1 of 1	
Issue Date: 07-Jul-2020					
Revision: B					

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